

0 to 10 kPa (0 to 1.45 PSI) On-Chip Temperature Compensated & Calibrated, Silicon Pressure Sensors

**MPX2010
MPX2012
SERIES**

Motorola Preferred Devices

**X-ducer™
SILICON
PRESSURE SENSORS**

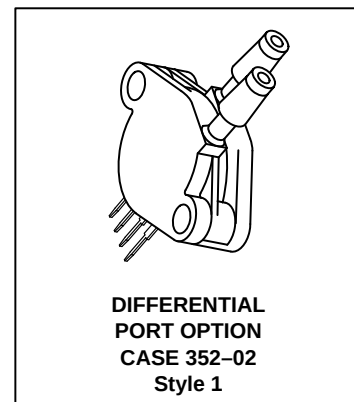
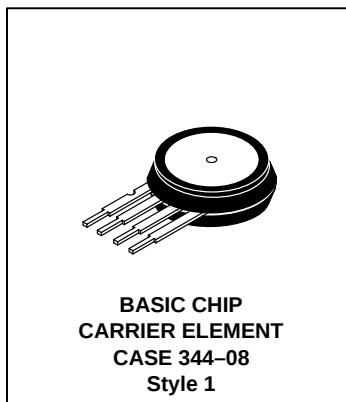
The MPX2010 and MPX2012 series silicon piezoresistive pressure sensors provide a very accurate and linear voltage output — directly proportional to the applied pressure. These sensors house a single monolithic silicon die with the strain gauge and thin-film resistor network integrated on each chip. The sensor is laser trimmed for precise span, offset calibration and temperature compensation.

Features

- Temperature Compensated over 0°C to +85°C
- Full Scale Span Calibrated to 25 mV (typical)
- Unique Silicon Shear Stress Strain Gauge
- $\pm 1.0\%$ (Max) Linearity
- Easy to use Chip Carrier Package Options
- Ratiometric to Supply Voltage
- Differential and Gauge Options

Application Examples

- Respiratory Diagnostics
- Air Movement Control
- Level Indicators
- Controllers
- Pressure Switching



Pin Number			
1	2	3	4
Ground	+V _{out}	V _S	-V _{out}

MAXIMUM RATINGS

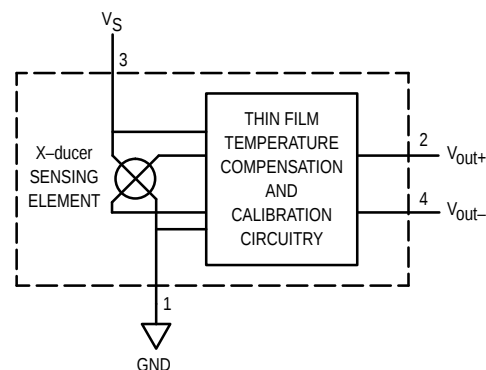
Rating	Symbol	Value	Unit
Overpressure ⁽⁸⁾ (P ₁ > P ₂)	P _{max}	75	kPa
Burst Pressure ⁽⁸⁾ (P ₁ > P ₂)	P _{burst}	100	kPa
Storage Temperature	T _{stg}	-50 to +150	°C
Operating Temperature	T _A	-40 to +125	°C

VOLTAGE OUTPUT versus APPLIED DIFFERENTIAL PRESSURE

The differential voltage output of the X-ducer is directly proportional to the differential pressure applied.

The output voltage of the differential or gauge sensor increases with increasing pressure applied to the pressure side (P₁) relative to the vacuum side (P₂). Similarly, output voltage increases as increasing vacuum is applied to the vacuum side (P₂) relative to the pressure side (P₁).

Figure 1 shows a block diagram of the internal circuitry on the stand-alone pressure sensor chip.



**Figure 1. Temperature Compensated
Pressure Sensor Schematic**

X-ducer is a trademark of Motorola, Inc.

Preferred devices are Motorola recommended choices for future use and best overall value.

MPX2010 MPX2012 SERIES

OPERATING CHARACTERISTICS ($V_S = 10\text{ Vdc}$, $T_A = 25^\circ\text{C}$ unless otherwise noted, $P_1 > P_2$)

Characteristic	Symbol	Min	Typ	Max	Unit
Pressure Range ⁽¹⁾	P _{OP}	0	—	10	kPa
Supply Voltage ⁽²⁾	V _S	—	10	16	Vdc
Supply Current	I _O	—	6.0	—	mAdc
Full Scale Span ⁽³⁾	V _{FSS}	24	25	26	mV
Offset ⁽⁴⁾	MPX2010 MPX2012	V _{off}	—	1.0	mV
			—	1.5	
Sensitivity	$\Delta V/\Delta P$	—	2.5	—	mV/kPa
Linearity ⁽⁵⁾	—	—1.0	—	1.0	%V _{FSS}
Pressure Hysteresis ⁽⁵⁾ (0 to 10 kPa)	—	—	±0.1	—	%V _{FSS}
Temperature Hysteresis ⁽⁵⁾ (–40°C to +125°C)	—	—	±0.5	—	%V _{FSS}
Temperature Effect on Full Scale Span ⁽⁵⁾	TCV _{FSS}	—1.0	—	1.0	%V _{FSS}
Temperature Effect on Offset ⁽⁵⁾	TCV _{off}	—1.0	—	1.0	mV
Input Impedance	Z _{in}	1300	—	2550	Ω
Output Impedance	Z _{out}	1400	—	3000	Ω
Response Time ⁽⁶⁾ (10% to 90%)	t _R	—	1.0	—	ms
Offset Stability ⁽⁵⁾	—	—	±0.5	—	%V _{FSS}

MECHANICAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
Weight (Basic Element Case 344)	—	—	2.0	—	Grams
Warm-Up	—	—	15	—	Sec
Cavity Volume	—	—	—	0.01	IN ³
Volumetric Displacement	—	—	—	0.001	IN ³
Common Mode Line Pressure ⁽⁷⁾	—	—	—	690	kPa

NOTES:

- 1.0 kPa (kiloPascal) equals 0.145 psi.
- Device is ratiometric within this specified excitation range. Operating the device above the specified excitation range may induce additional error due to device self-heating.
- Full Scale Span (V_{FSS}) is defined as the algebraic difference between the output voltage at full rated pressure and the output voltage at the minimum rated pressure.
- Offset (V_{off}) is defined as the output voltage at the minimum rated pressure.
- Accuracy (error budget) consists of the following:
 - Linearity: Output deviation from a straight line relationship with pressure, using end point method, over the specified pressure range.
 - Temperature Hysteresis: Output deviation at any temperature within the operating temperature range, after the temperature is cycled to and from the minimum or maximum operating temperature points, with zero differential pressure applied.
 - Pressure Hysteresis: Output deviation at any pressure within the specified range, when this pressure is cycled to and from the minimum or maximum rated pressure, at 25°C.
 - Offset Stability: Output deviation, after 1000 temperature cycles, – 40 to 125°C, and 1.5 million pressure cycles, with zero differential pressure applied.
 - TcSpan: Output deviation at full rated pressure over the temperature range of 0 to 85°C, relative to 25°C.
 - TcOffset: Output deviation with minimum rated pressure applied, over the temperature range of 0 to 85°C, relative to 25°C.
- Response Time is defined as the time for the incremental change in the output to go from 10% to 90% of its final value when subjected to a specified step change in pressure.
- Common mode pressures beyond specified may result in leakage at the case-to-lead interface.
- Exposure beyond these limits may cause permanent damage or degradation to the device.

ON-CHIP TEMPERATURE COMPENSATION and CALIBRATION

Figure 2 shows the output characteristics of the MPX2010 series at 25°C. The output is directly proportional to the differential pressure and is essentially a straight line.

The effects of temperature on full scale span and offset are very small and are shown under Operating Characteristics.

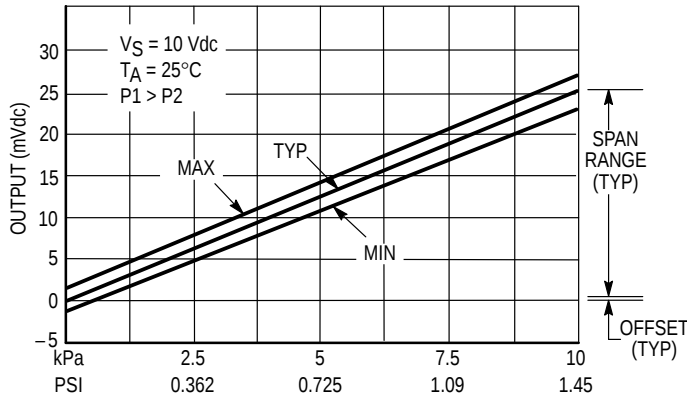


Figure 2. Output versus Pressure Differential

This performance over temperature is achieved by having both the shear stress strain gauge and the thin-film resistor circuitry on the same silicon diaphragm. Each chip is dynamically laser trimmed for precise span and offset calibration and temperature compensation.

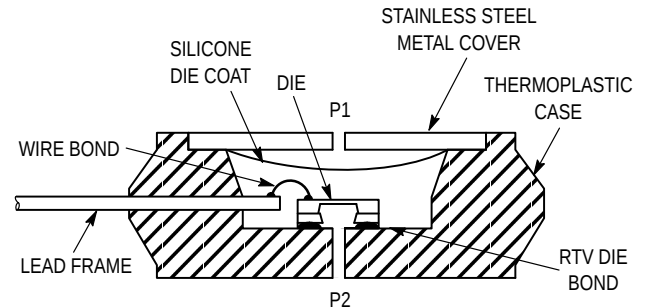


Figure 3. Cross-Sectional Diagram (not to scale)

Figure 3 illustrates the differential/gauge die in the basic chip carrier (Case 344). A silicone gel isolates the die surface and wire bonds from harsh environments, while allowing the pressure signal to be transmitted to the silicon diaphragm.

The MPX2010 series pressure sensor operating charac-

teristics and internal reliability and qualification tests are based on use of dry air as the pressure media. Media other than dry air may have adverse effects on sensor performance and long term reliability. Contact the factory for information regarding media compatibility in your application.

LINEARITY

Linearity refers to how well a transducer's output follows the equation: $V_{out} = V_{off} + \text{sensitivity} \times P$ over the operating pressure range. There are two basic methods for calculating nonlinearity: (1) end point straight line fit (see Figure 4) or (2) a least squares best line fit. While a least squares fit gives the "best case" linearity error (lower numerical value), the calculations required are burdensome.

Conversely, an end point fit will give the "worst case" error (often more desirable in error budget calculations) and the calculations are more straightforward for the user. Motorola's specified pressure sensor linearities are based on the end point straight line method measured at the midrange pressure.

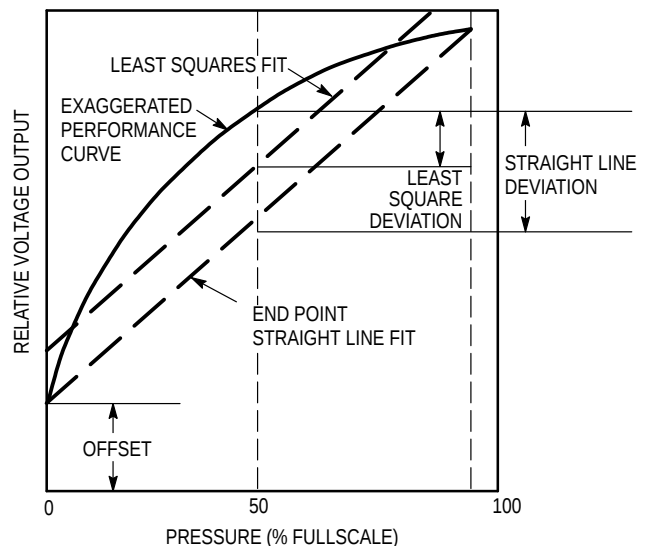


Figure 4. Linearity Specification Comparison

MPX2010 MPX2012 SERIES

PRESSURE (P1)/VACUUM (P2) SIDE IDENTIFICATION TABLE

Motorola designates the two sides of the pressure sensor as the Pressure (P1) side and the Vacuum (P2) side. The Pressure (P1) side is the side containing silicone gel which protects the die from harsh media. The Motorola MPX pres-

sure sensor is designed to operate with positive differential pressure applied, $P1 > P2$.

The Pressure (P1) side may be identified by using the table below:

Part Number		Case Type	Pressure (P1) Side Identifier
MPX2010D	MPX2012D	344-08	Stainless Steel Cap
MPX2010DP	MPX2012DP	352-02	Side with Part Marking
MPX2010GP	MPX2012GP	350-03	Side with Port Attached
MPX2010GVP	MPX2012GVP	350-04	Stainless Steel Cap
MPX2010GS	MPX2012GS	371-06	Side with Port Attached
MPX2010GVS	MPX2012GVS	371-05	Stainless Steel Cap
MPX2010GSX	MPX2012GSX	371C-02	Side with Port Attached
MPX2010GVSX	MPX2012GVSX	371D-02	Stainless Steel Cap

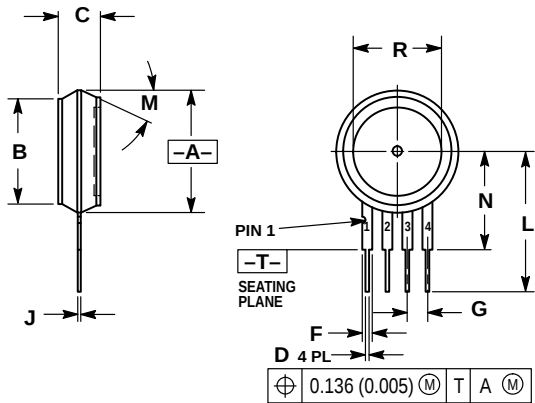
ORDERING INFORMATION

MPX2010 series pressure sensors are available in differential and gauge configurations. Devices are available in the basic element package or with pressure port fittings which provide printed circuit board mounting ease and barbed hose pressure connections.

Device Type	Options	Case Type	MPX Series	
			Order Number	Device Marking
Basic Element	Differential	Case 344-08	MPX2010D MPX2012D	MPX2010D MPX2012D
Ported Elements	Differential	Case 352-02	MPX2010DP MPX2012DP	MPX2010DP MPX2012DP
	Gauge	Case 350-03	MPX2010GP MPX2012GP	MPX2010GP MPX2012GP
	Gauge Vacuum	Case 350-04	MPX2010GVP MPX2012GVP	MPX2010GVP MPX2012GVP
	Gauge Stove Pipe	Case 371-06	MPX2010GS MPX2012GS	MPX2010D MPX2012D
	Gauge Vacuum Stove Pipe	Case 371-05	MPX2010GVS MPX2012GVS	MPX2010D MPX2012D
	Gauge Axial	Case 371C-02	MPX2010GSX MPX2012GSX	MPX2010D MPX2012D
	Gauge Vacuum Axial	Case 371D-02	MPX2010GVSX MPX2012GVSX	MPX2010D MPX2012D

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PACKAGE DIMENSIONS



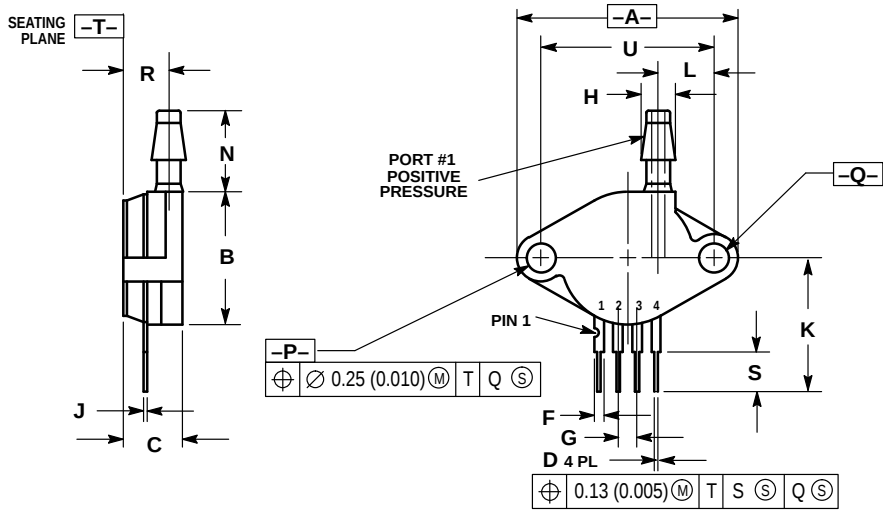
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.590	0.615	14.99	15.62
B	0.505	0.525	12.83	13.34
C	0.195	0.225	4.95	5.72
D	0.016	0.020	0.41	0.51
F	0.048	0.052	1.22	1.32
G	0.100 BSC		2.54 BSC	
J	0.014	0.016	0.36	0.40
L	0.685	0.715	17.40	18.16
M	30° NOM		30° NOM	
N	0.480	0.500	12.19	12.70
R	0.420	0.450	10.67	11.43

STYLE 1:
PIN 1. GROUND
2. + OUTPUT
3. + SUPPLY
4. - OUTPUT

CASE 344-08
ISSUE M

BASIC ELEMENT (A, D)



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1982.
2. CONTROLLING DIMENSION: INCH.

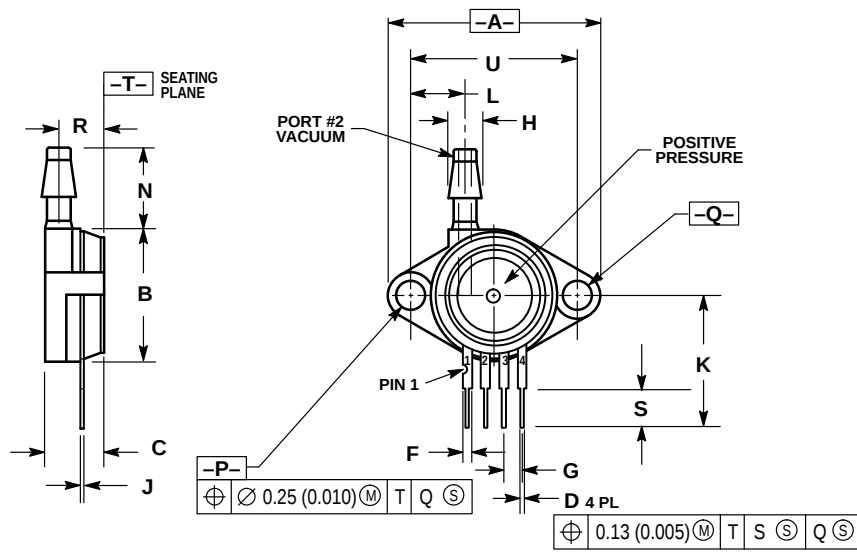
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.140	1.180	28.95	29.97
B	0.685	0.751	17.39	18.16
C	0.305	0.321	7.74	8.15
D	0.016	0.020	0.40	0.50
F	0.048	0.052	1.21	1.32
G	0.100 BSC		2.54 BSC	
H	0.182	0.194	4.62	4.92
J	0.014	0.016	0.35	0.40
K	0.685	0.715	17.39	18.16
L	0.290	0.300	7.34	7.62
N	0.420	0.440	10.67	11.12
P	0.153	0.158	3.88	4.01
Q	0.153	0.158	3.88	4.01
R	0.231	0.250	5.86	6.35
S	0.230 REF		5.84 REF	
U	0.910 BSC		23.11 BSC	

STYLE 1:
PIN 1. GROUND
2. + OUTPUT
3. + SUPPLY
4. - OUTPUT

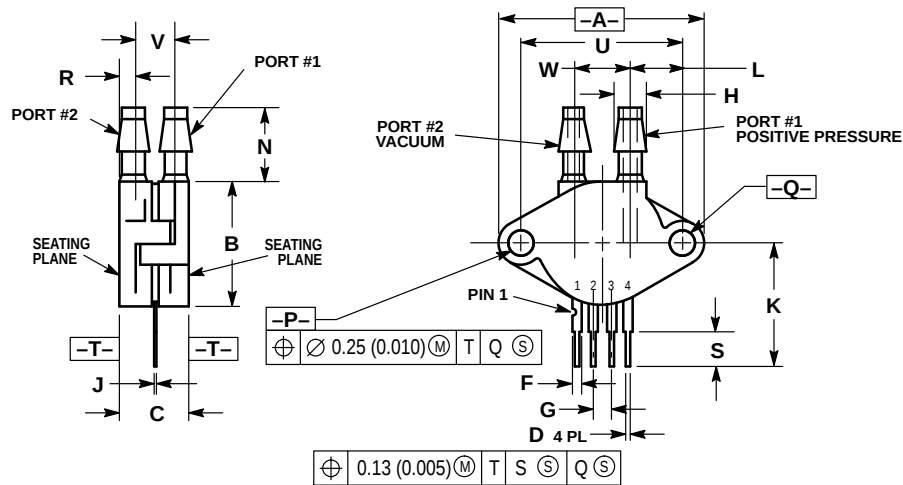
CASE 350-03
ISSUE H

PRESSURE SIDE PORTED (AP, GP)

PACKAGE DIMENSIONS — CONTINUED

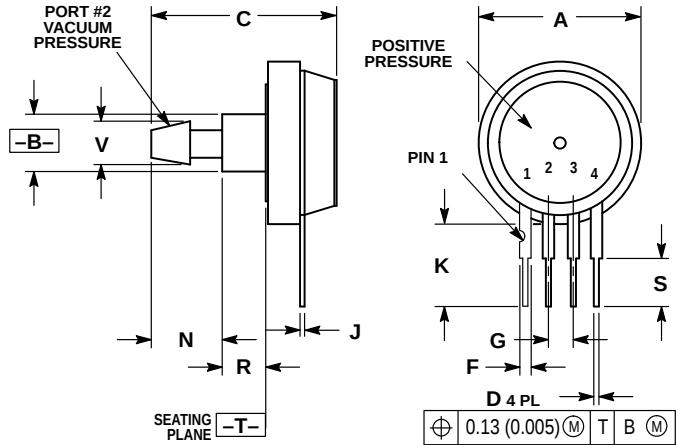
CASE 350-04
ISSUE H

VACUUM SIDE PORTED (GVP)

CASE 352-02
ISSUE F

PRESSURE AND VACUUM SIDES PORTED (DP)

PACKAGE DIMENSIONS — CONTINUED



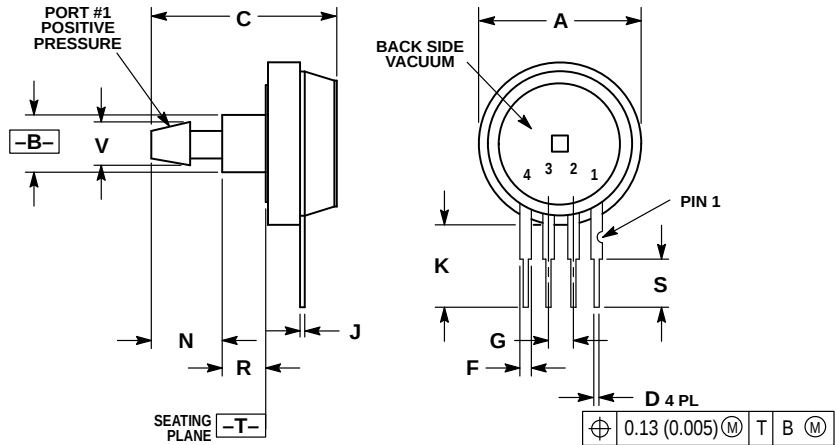
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.690	0.720	17.53	18.28
B	0.247	0.253	6.28	6.42
C	0.780	0.820	19.81	20.82
D	0.016	0.020	0.41	0.50
F	0.048	0.052	1.22	1.32
G	0.100 BSC		2.54 BSC	
J	0.014	0.016	0.36	0.40
K	0.335	0.365	8.51	9.27
N	0.305	0.315	7.75	8.00
R	0.178	0.185	4.53	4.69
S	0.230 REF		5.84 REF	
V	0.182	0.194	4.63	4.92

STYLE 1:
PIN 1. GROUND
2. + OUTPUT
3. + SUPPLY
4. - OUTPUT

CASE 371-05
ISSUE D

VACUUM SIDE PORTED (GVS)



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.690	0.720	17.53	18.28
B	0.247	0.253	6.28	6.42
C	0.780	0.820	19.81	20.82
D	0.016	0.020	0.41	0.50
F	0.048	0.052	1.22	1.32
G	0.100 BSC		2.54 BSC	
J	0.014	0.016	0.36	0.40
K	0.335	0.365	8.51	9.27
N	0.305	0.315	7.75	8.00
R	0.178	0.185	4.53	4.69
S	0.230 REF		5.84 REF	
V	0.182	0.194	4.63	4.92

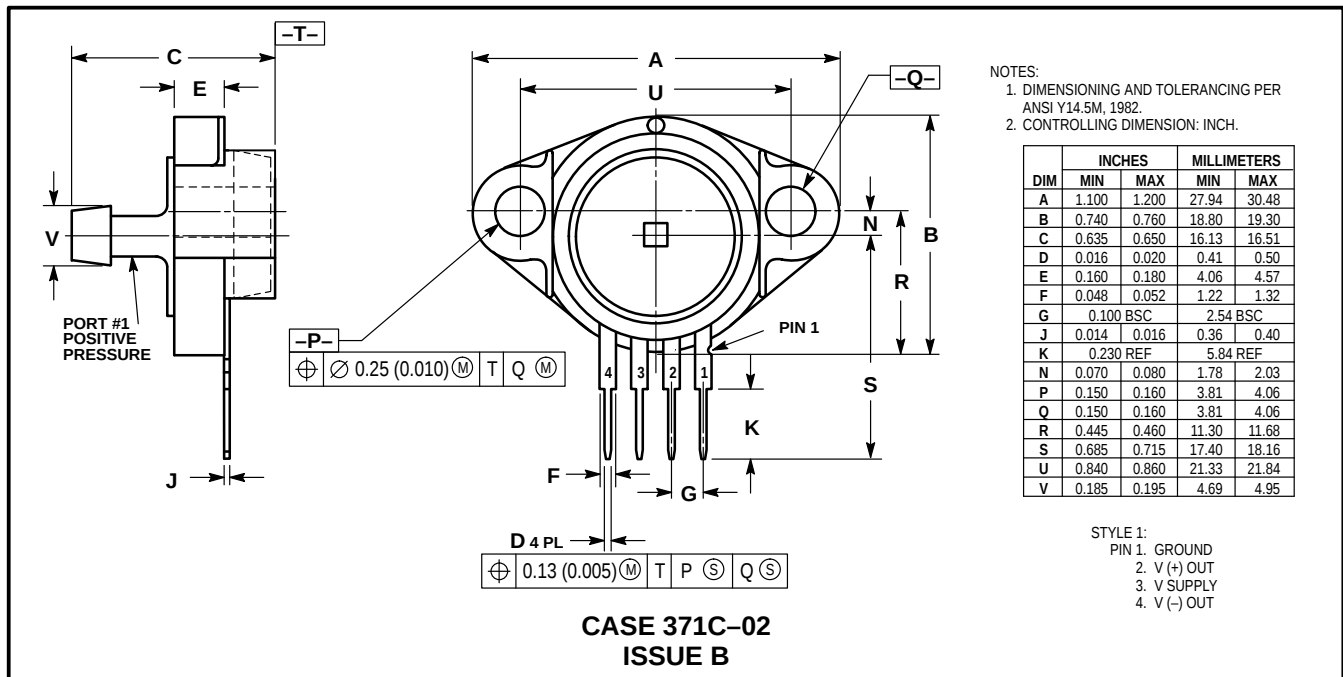
STYLE 1:
PIN 1. GROUND
2. + OUTPUT
3. + SUPPLY
4. - OUTPUT

CASE 371-06
ISSUE D

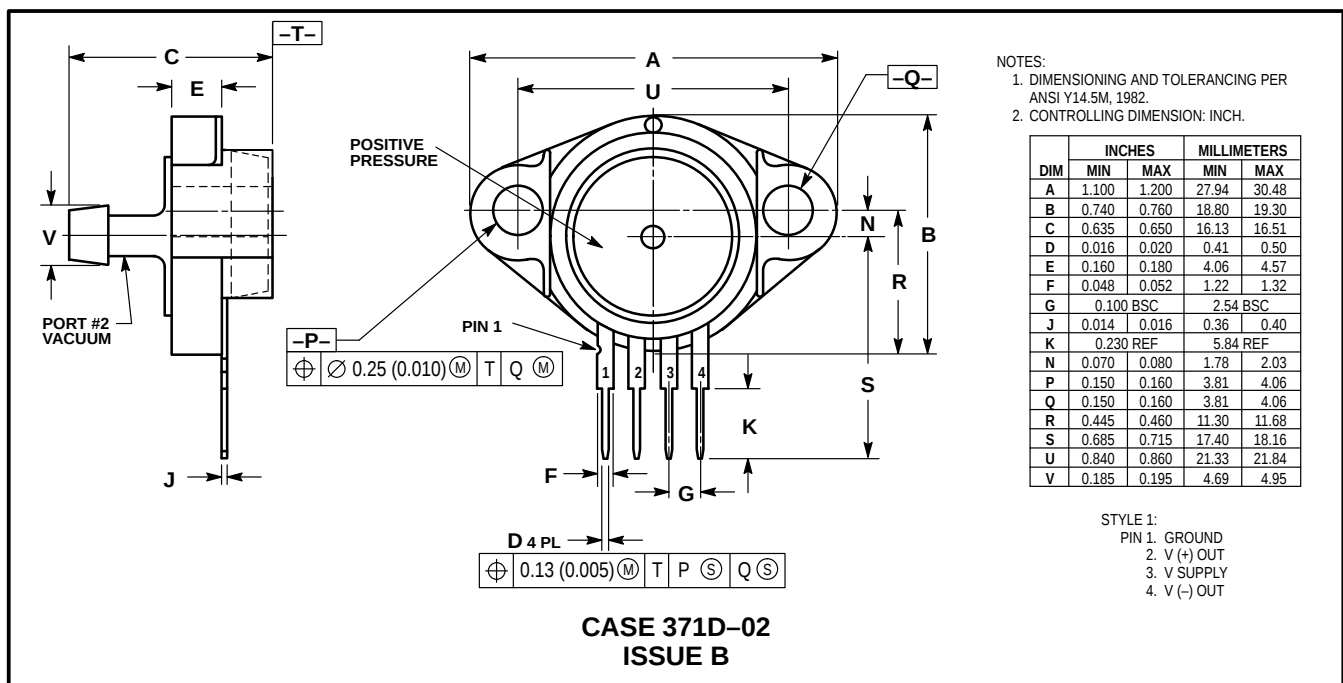
PRESSURE SIDE PORTED (AS, GS)

MPX2010 MPX2012 SERIES

PACKAGE DIMENSIONS — CONTINUED



PRESSURE SIDE PORTED (ASX, GSX)



VACUUM SIDE PORTED (GVSX)

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MPX2010/D

